

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D@25^{\circ}C$
750V	11m $\Omega@18V$	210A

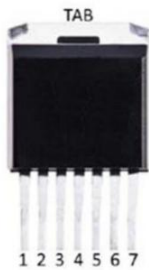
### Feature

- Wide bandgap SiC MOSFET technology
- Low On-Resistance with high blocking voltage
- Low capacitances with High-Speed switching
- Low reverse recovery(Qrr)

### Application

- Switch mode power supplies
- Renewable energy
- On Board Charger
- High voltage DC/DC converters

### Package

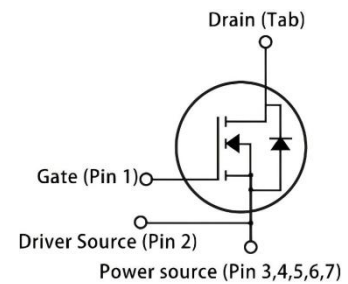


TO-263-7L

### Marking



### Circuit diagram



### Absolute maximum ratings ( $T_c=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Value	Unit
Drain-Source Voltage	$V_{DSmax}$	$V_{GS} = 0V, I_D = 100\mu A$	750	V
Gate-Source Voltage(transient)	$V_{GS}$	$t_p \leq 500ns, \text{duty cycle} \leq 1\%$	-8/+20	V
Gate-Source Voltage	$V_{GSOP}$	Static	-4/+18	V
Continuous Drain Current	$I_D$	$V_{GS} = 18V$	210	A
	$I_D$	$V_{GS} = 18V, T_c = 100^{\circ}C$	148	A
Pulsed Drain Current	$I_{D,pulse}$	Pulse with $t_p$ limited by $T_{jmax}$	503	A
Power Dissipation	$P_D$	$T_J = 175^{\circ}C$	714	W
Thermal Resistance (Typ)	$R_{\theta JC}$	Junction-to-Case	0.21	$^{\circ}C/W$
Operating Junction Temperature	$T_J$		-55~ +175	$^{\circ}C$
Storage Temperature	$T_{STG}$		-55~ +175	$^{\circ}C$

### Electrical characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 100μA	750			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 750V, V <sub>GS</sub> = 0V			50	μA
Gate-Source leakage current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 18V			250	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 36mA		2.8		V
		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 36mA, T <sub>J</sub> = 175°C		2		
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 18V, I <sub>D</sub> = 80A		11	15	mΩ
		V <sub>GS</sub> = 18V, I <sub>D</sub> = 80A, T <sub>J</sub> = 175°C		14		
Transconductance	g <sub>fs</sub>	V <sub>GS</sub> = 18V, I <sub>D</sub> = 80A		60		S
		V <sub>GS</sub> = 18V, I <sub>D</sub> = 80A, T <sub>J</sub> = 175°C		54		
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V V <sub>AC</sub> = 25mV, f = 1MHz		5670		pF
Output Capacitance	C <sub>oss</sub>			383		
Reverse Transfer Capacitance	C <sub>rss</sub>			37		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 400V, V <sub>GS</sub> = -4V/18V I <sub>D</sub> = 80A		235		nC
Gate-Source Charge	Q <sub>gs</sub>			84		
Gate-Drain Charge	Q <sub>gd</sub>			62		
Internal Gate Resistance	R <sub>G(int)</sub>	V <sub>AC</sub> = 25mV, f = 1MHz		1.2		Ω
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DS</sub> = 400V, V <sub>GS</sub> = -4/+18V I <sub>D</sub> = 80A, R <sub>G(ext)</sub> = 5Ω, L = 100μH		8		nS
Turn-on rise time	t <sub>r</sub>			35		
Turn-off delay time	t <sub>d(off)</sub>			38		
Turn-off fall time	t <sub>f</sub>			9		
Turn-On Energy	E <sub>on</sub>			222		μJ
Turn-Off Energy	E <sub>off</sub>			370		
Total switching energy	E <sub>tot</sub>			592		
<b>Source-Drain Diode characteristics</b>						
Diode Forward Current	I <sub>S</sub>	V <sub>GS</sub> = -4V, T <sub>C</sub> = 25°C		152		A
Diode Forward voltage	V <sub>SD</sub>	V <sub>GS</sub> = -4V, I <sub>SD</sub> = 40A		3.9		V
		V <sub>GS</sub> = -4V, I <sub>SD</sub> = 40A, T <sub>J</sub> = 175°C		3.4		
Reverse Recovery Time	T <sub>rr</sub>	V <sub>GS</sub> = -4V, V <sub>R</sub> = 400V, I <sub>SD</sub> = 80A dif/dt = 3000 A/μs		22		nS
Reverse Recovery Charge	Q <sub>rr</sub>			335		nC
Peak Reverse Recovery Current	I <sub>rrm</sub>			32		A

## Typical Characteristics

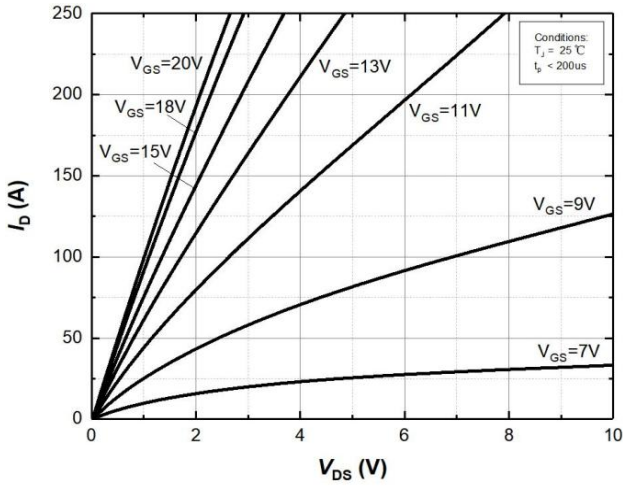


Figure 1. Output characteristics at  $T_j=25^\circ\text{C}$

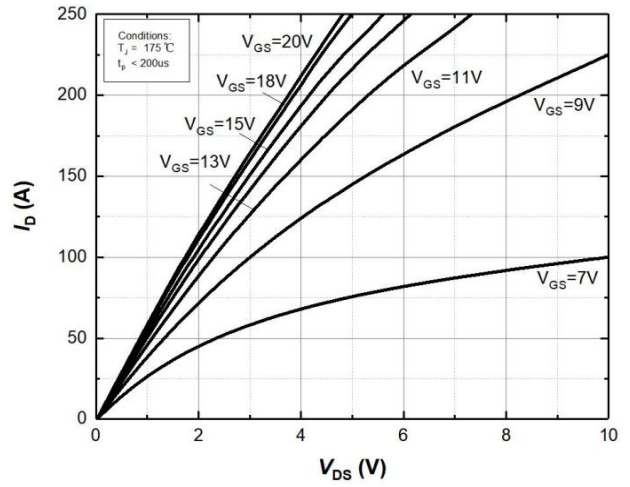


Figure 2. Output characteristics at  $T_j=175^\circ\text{C}$

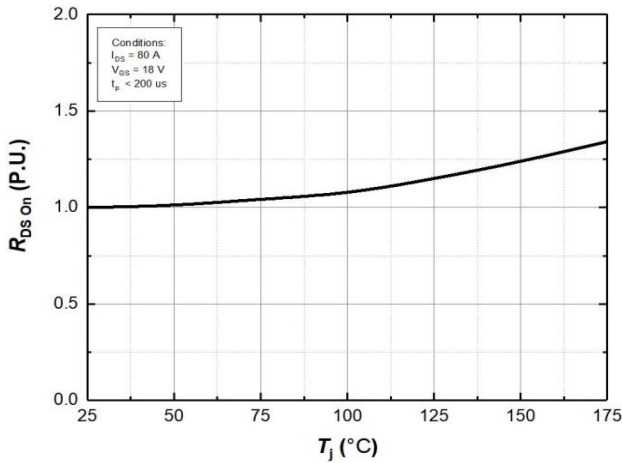


Figure 3. Normalized On-Resistance vs. Temperature

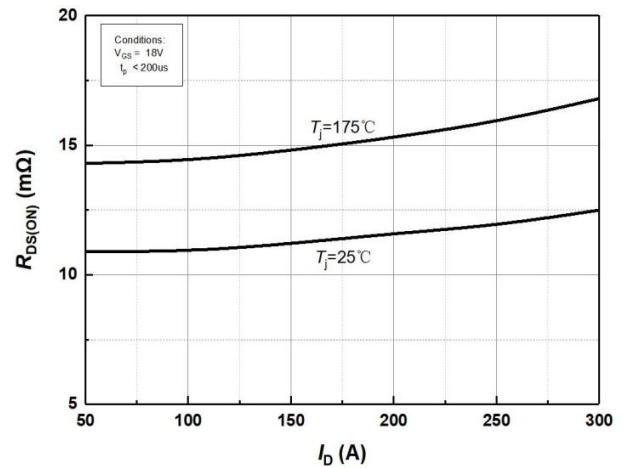


Figure 4. On-Resistance vs. Drain current for Various Temperature

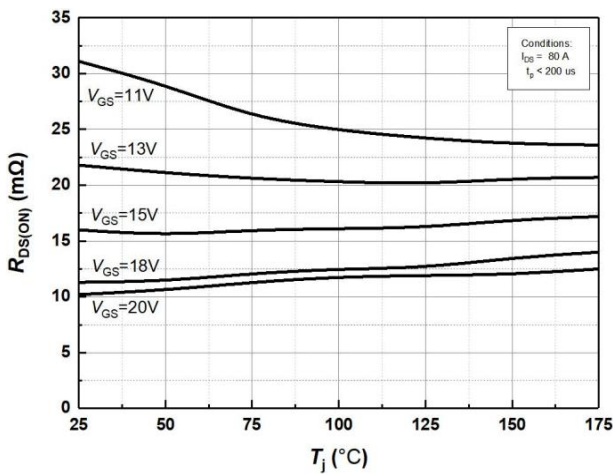


Figure 5. On-Resistance vs. Temperature for Various Gate Voltage

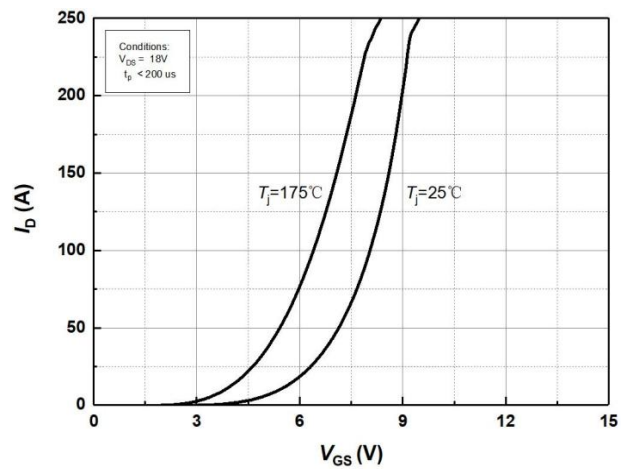


Figure 6. Transfer Characteristics for Various Junction Temperatures

## Typical Characteristics

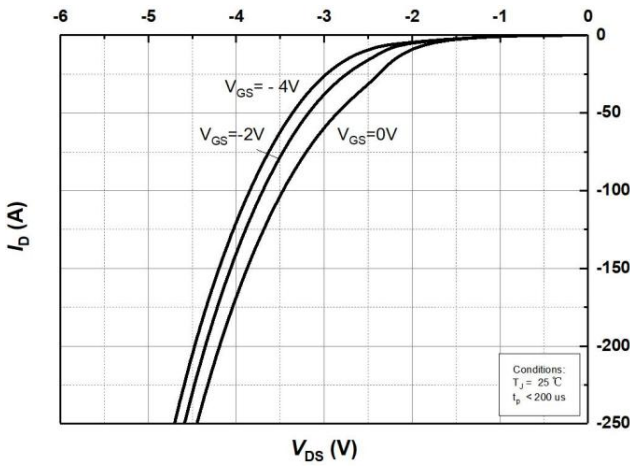


Figure 7. Body Diode Characteristics at  $T_j=25^\circ\text{C}$

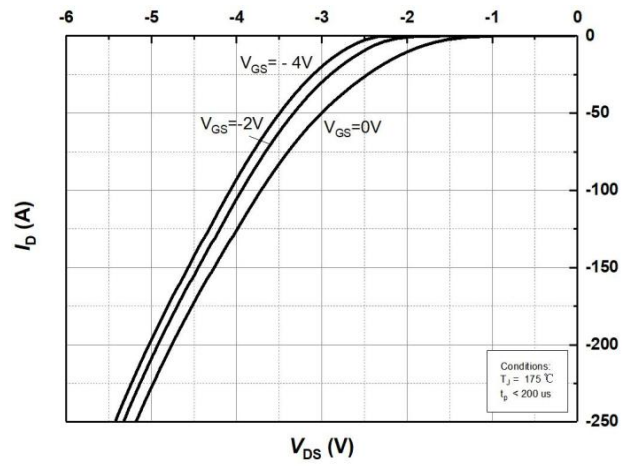


Figure 8. Body Diode Characteristics at  $T_j=175^\circ\text{C}$

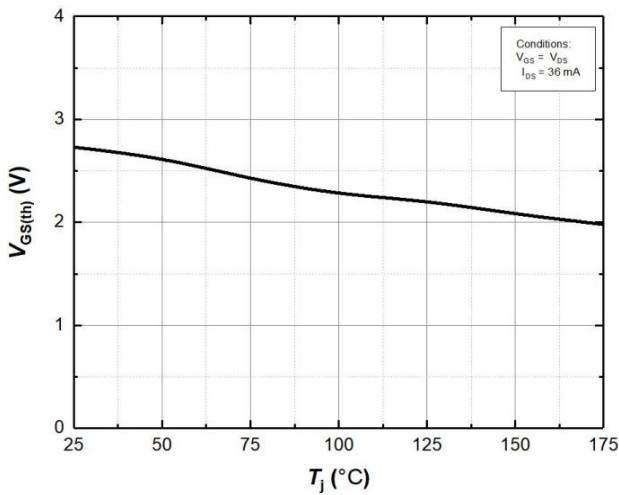


Figure 9. Threshold Voltage vs. Temperature

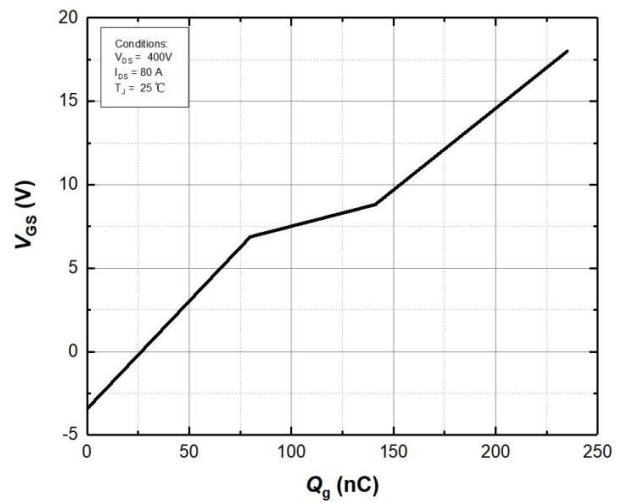


Figure 10 Gate Charge Characteristics

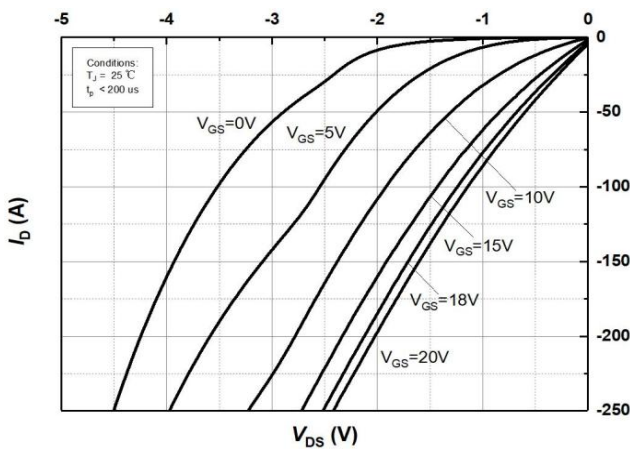


Figure 11. 3rd Quadrant Characteristic at  $T_j=25^\circ\text{C}$

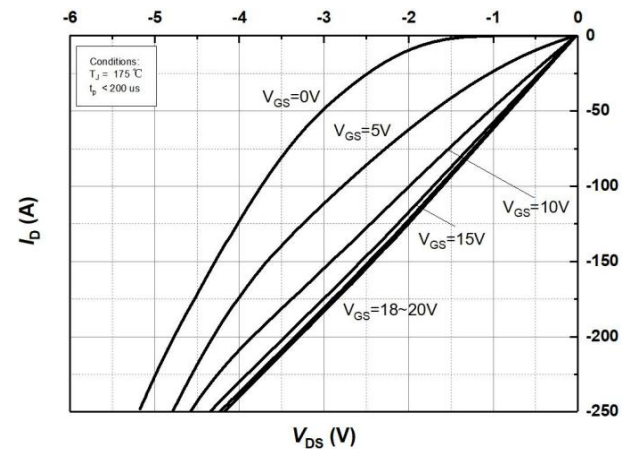


Figure 12. 3rd Quadrant Characteristic at  $T_j=175^\circ\text{C}$

## Typical Characteristics

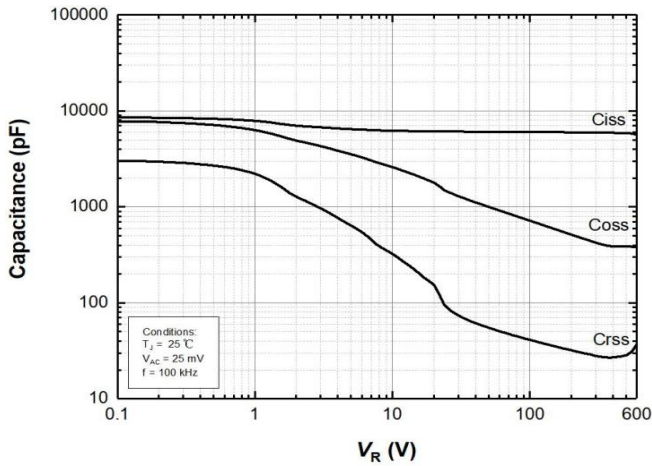


Figure 13. Capacitances vs. Drain-Source Voltage (0 – 600V)

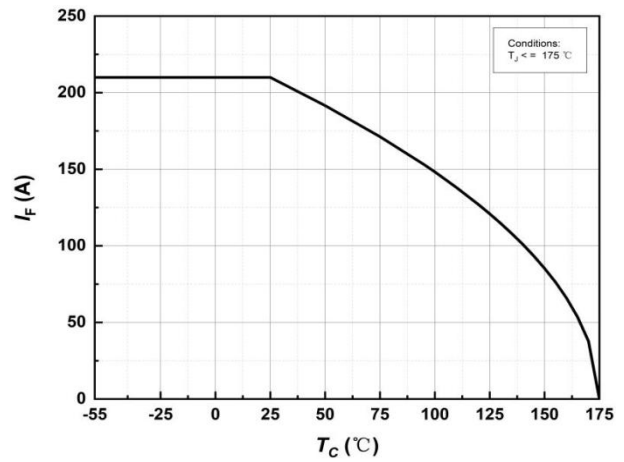


Figure 14. Continuous Drain Current Derating vs Case Temperature

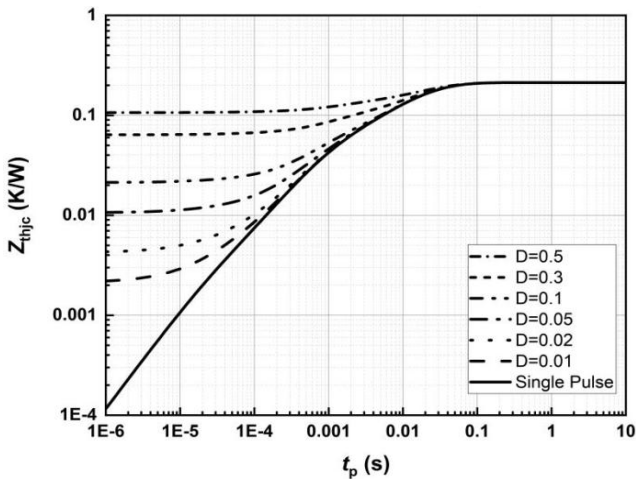


Figure 15. Transient Thermal Impedance (Junction – Case)

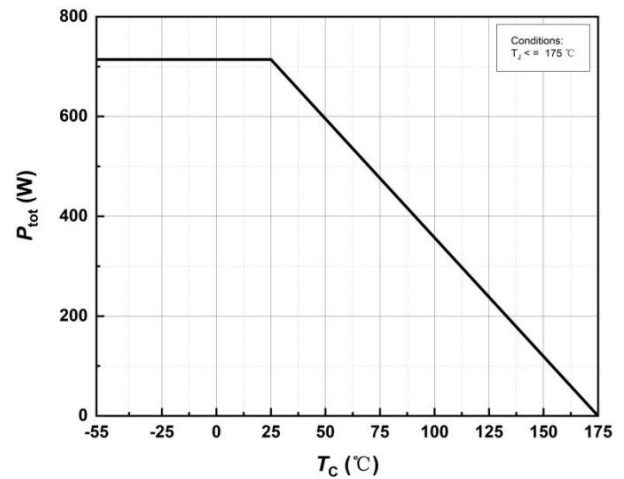


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

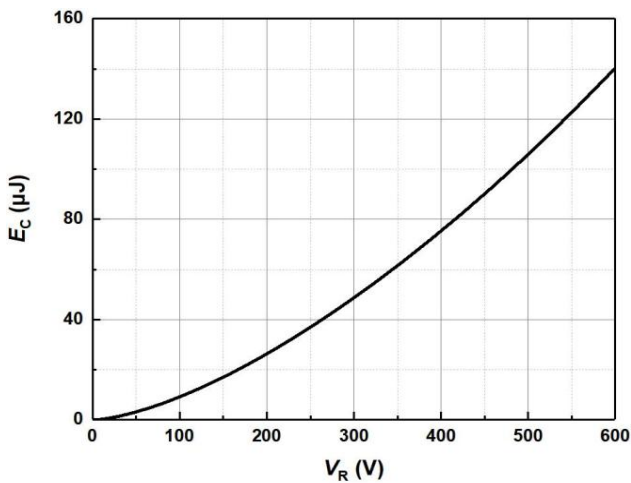


Figure 17. Output Capacitor Stored Energy

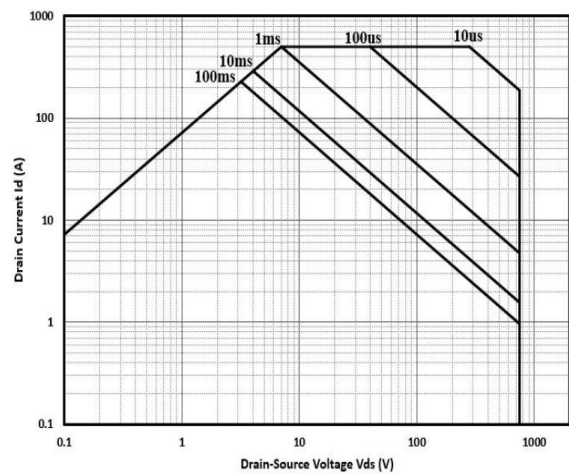


Figure 18. Safe Operating Area

## Typical Characteristics

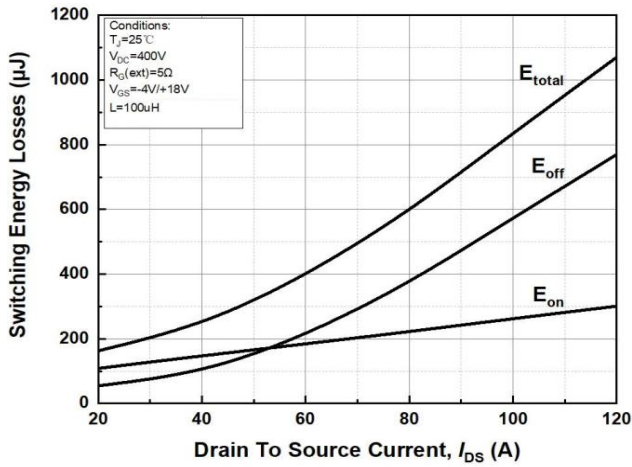


Figure 19. Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 400V$ )

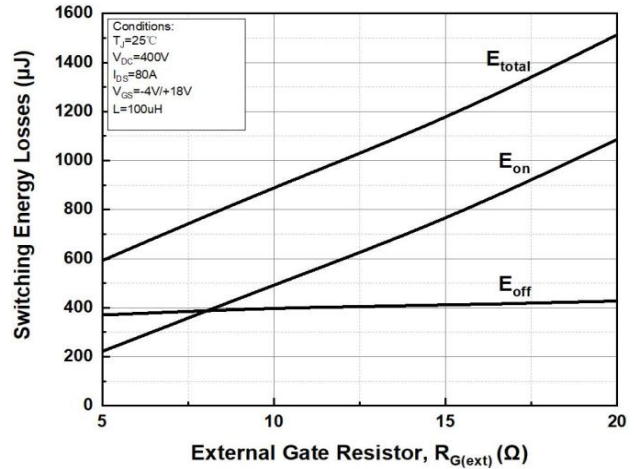


Figure 20. Clamped Inductive Switching Energy vs.  $R_{G(ext)}$

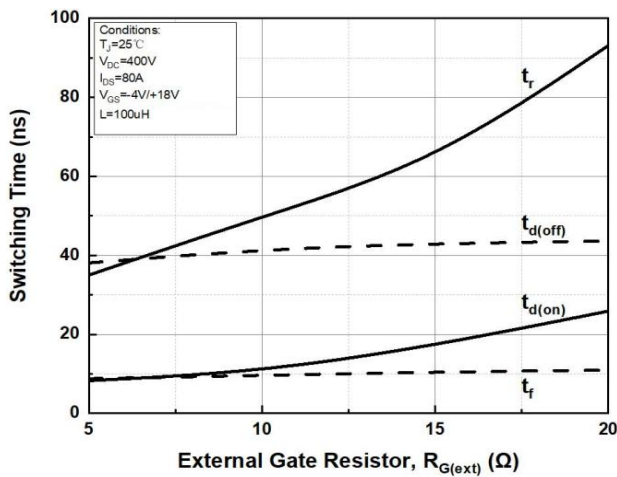
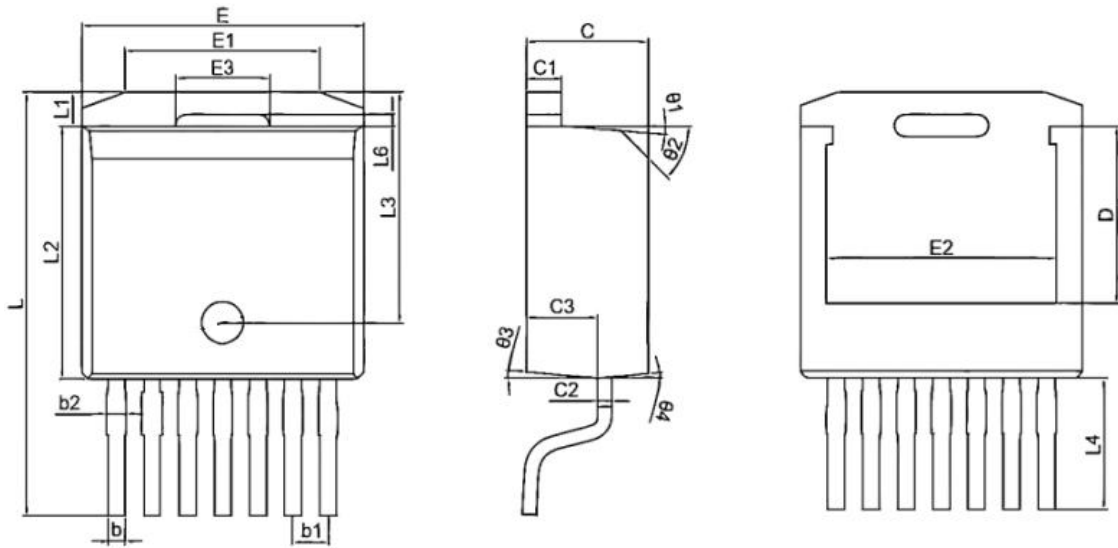


Figure 21. Switching Times vs.  $R_{G(ext)}$

### TO-263-7L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
E	10.080	10.280	0.397	0.405
E1	6.800	7.200	0.268	0.283
E2	8.100	8.500	0.319	0.335
E3	3.000	3.400	0.118	0.134
L	14.950	15.450	0.589	0.608
L1	0.950	1.450	0.037	0.057
L2	8.880	9.280	0.350	0.365
L3	7.980	8.580	0.314	0.338
L4	4.650	4.950	0.183	0.195
L6	0.350	0.450	0.014	0.018
b	0.500	0.700	0.020	0.028
b1	1.200	1.340	0.047	0.053
b2	0.600	0.800	0.024	0.031
C	4.280	4.580	0.169	0.180
C1	1.200	1.400	0.047	0.055
C2	0.430	0.570	0.017	0.022
C3	2.450	2.750	0.096	0.108
D	6.300	6.600	0.248	0.260
θ1	3°	7°	3°	7°
θ2	43°	47°	43°	47°
θ3	3°	7°	3°	7°
θ4	3°	7°	3°	7°